

**AMENDMENT TO THE SPECIFICATION:**

Please amend the paragraph beginning on page 24, line 28 as follows:

--The tip of the optical fiber 8 is fixed, as inserted in the mounting hole 18, to the light-receiving photo-semiconductor device A on its mounting face  $A_1$  [[.sub.1]] (on the face on which the input/output terminal electrode is formed) using the encapsulating resin

5. This configuration permits the tip of the optical fiber 8 to come close to the photo-absorbing layer of the PinPD1 as much as possible, thus preserving a sufficient level of light receiving sensitivity.--